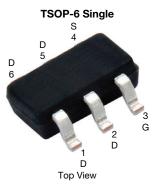


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Vishay Siliconix

Automotive P-Channel 12 V (D-S) 175 °C MOSFET



Marking Code: 8UY

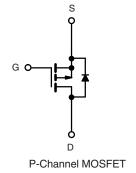
PRODUCT SUMMARY					
V _{DS} (V)	-12				
$R_{DS(on)}(\Omega)$ at $V_{GS} = -4.5 \text{ V}$	0.025				
$R_{DS(on)}(\Omega)$ at $V_{GS} = -2.5 \text{ V}$	0.032				
$R_{DS(on)}(\Omega)$ at $V_{GS} = -1.8 \text{ V}$	0.043				
I _D (A)	-8				
Configuration	Single				

FEATURES

- TrenchFET® power MOSFET
- AEC-Q101 qualified c
- 100 % R_q and UIS tested
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912







ORDERING INFORMATION	
Package	TSOP-6
Lead (Pb)-free and halogen-free	SQ3461EV (for detailed order number please see www.vishay.com/doc?79771)

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	-12	V	
Gate-source voltage		V _{GS}	± 8	V	
Continuous drain current ^c	T _C = 25 °C	1	-8		
	T _C = 125 °C	I _D	-6.6		
Continuous source current (diode conduction	on)	I _S	-6.3	Α	
Pulsed drain current ^a		I _{DM}	-30		
Single pulse avalanche current	L = 0.1 mH	I _{AS}	-17		
Single pulse avalanche energy	L=U.I MH	E _{AS}	14	mJ	
Maximum power dissination 8	T _C = 25 °C	D	5	W	
Maximum power dissipation ^a	T _C = 125 °C	P_{D}	1.67		
Operating junction and storage temperature	e range	T _J , T _{stq}	-55 to +175	°C	

THERMAL RESISTANCE RATINGS							
PARAMETER		SYMBOL	LIMIT	UNIT			
Junction to ambient	PCB mount ^b	R_{thJA}	110	°C/W			
Junction to case (drain)		R_{thJF}	30	G/VV			

Notes

- a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %
- b. When mounted on 1" square PCB (FR4 material)
- c. Package limited



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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static								
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_{D} = -250 \mu\text{A}$		-12	-	-	V	
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	V _{DS} = V _{GS} , I _D = -250 μA		-0.6	-1	V	
Gate-Source Leakage	I _{GSS}	V _{DS} =	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$		-	± 100	nA	
	I _{DSS}	V _{GS} = 0 V	V _{DS} = -12 V	=	-	-1		
Zero Gate Voltage Drain Current		V _{GS} = 0 V	V _{DS} = -12 V, T _J = 125 °C	=	-	-50	μΑ	
		V _{GS} = 0 V	V _{DS} = -12 V, T _J = 175 °C	-	-	-150		
On-State Drain Current ^a	I _{D(on)}	V _{GS} = -4.5 V	V _{DS} = -5 V	-11	-	-	Α	
		V _{GS} = -4.5 V	I _D = -7.9 A	-	0.021	0.025	Ω	
		V _{GS} = -4.5 V	I _D = -6.6 A, T _J = 125 °C	-	-	0.033		
Drain-Source On-State Resistance a	R _{DS(on)}	$V_{GS} = -4.5 \text{ V}$	I _D = -3.5 A, T _J = 175 °C	-	-	0.037		
		$V_{GS} = -2.5 \text{ V}$	$I_D = -7 A$	1	0.026	0.032		
		V _{GS} = -1.8 V	$I_D = -3 A$	-	0.036	0.043		
Forward Transconductance b	9 _{fs}	V _{DS} =	= -5 V, I _D = -7.9 A	-	21	-	S	
Dynamic ^b								
Input Capacitance	C _{iss}			-	1600	2000		
Output Capacitance	C _{oss}	$V_{GS} = 0 V$	V _{DS} = -6 V, f = 1 MHz	1	620	770	pF	
Reverse Transfer Capacitance	C _{rss}			1	490	620		
Total Gate Charge ^c	Qg			1	21	28		
Gate-Source Charge ^c	Q_{gs}	$V_{GS} = -4.5 \text{ V}$	$V_{DS} = -6 \text{ V}, I_{D} = -7.9 \text{ A}$	ı	2.5	ı	nC	
Gate-Drain Charge ^c	Q_{gd}			1	7	1		
Gate Resistance	R_g	f = 1 MHz		2.8	5.7	8.6	Ω	
Turn-On Delay Time ^c	t _{d(on)}			-	12	17		
Rise Time ^c	t _r	$V_{DD} = -6 \text{ V}, \text{ R}_{L} = 1.6 \Omega$ $I_{D} \cong -7.9 \text{ A}, \text{ V}_{GEN} = -4.5 \text{ V}, \text{ R}_{g} = 1 \Omega$		-	52	68	ns ns	
	t _{d(off)}			ı	92	120		
Turn-Off Delay Time ^c	- u(011)							
Turn-Off Delay Time ° Fall Time °	t _f			-	71	93		
<u> </u>	t _f			-	71	93		
Fall Time c	t _f			-	71 -	-20	A	

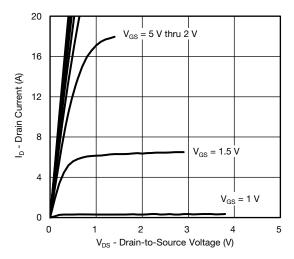
Notes

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

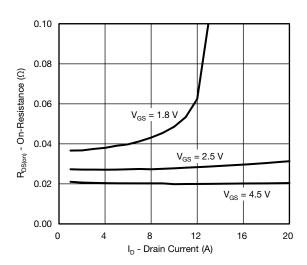
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



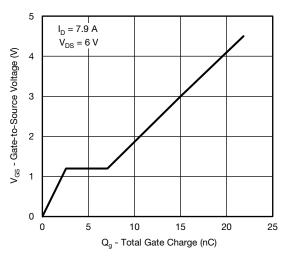
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



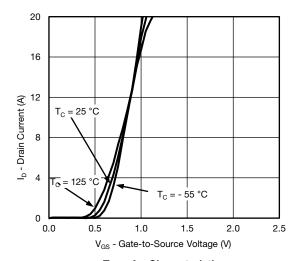
Output Characteristics



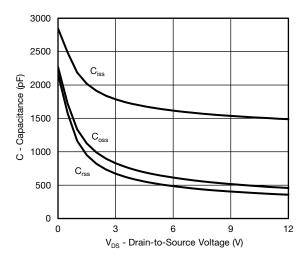
On-Resistance vs. Drain Current



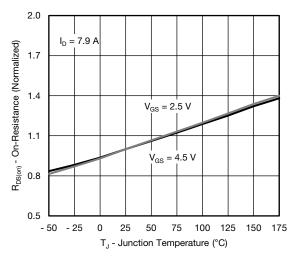
Gate Charge



Transfer Characteristics



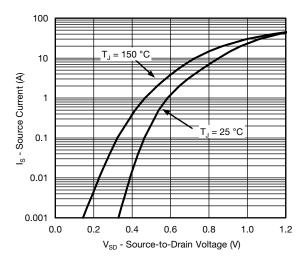
Capacitance



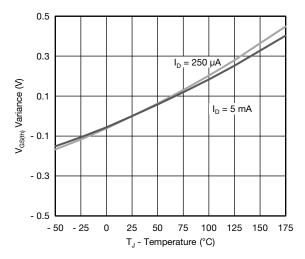
On-Resistance vs. Junction Temperature



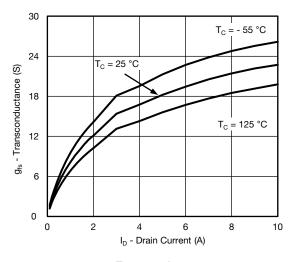
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



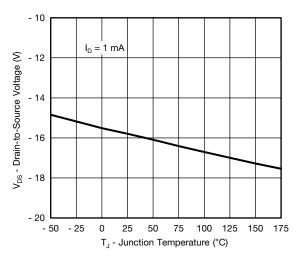
Source-Drain Diode Forward Voltage



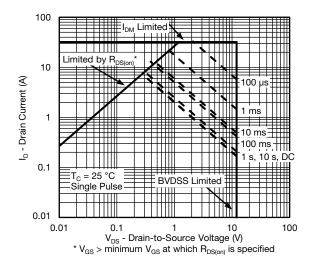
Threshold Voltage



Transconductance



Drain-to- Source Voltage vs. Junction Temperature





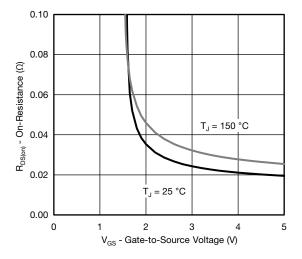


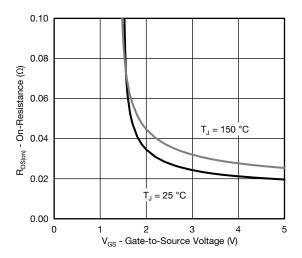
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Safe Operating Area



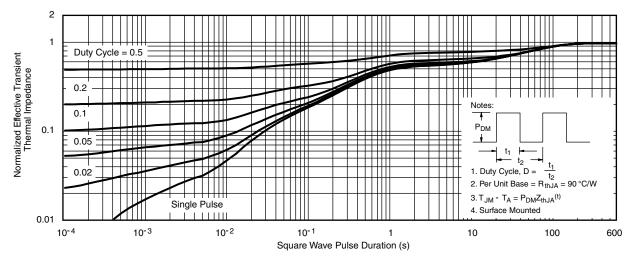
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)





On-Resistance vs. Gate-to-Source Voltage (7.9 A)

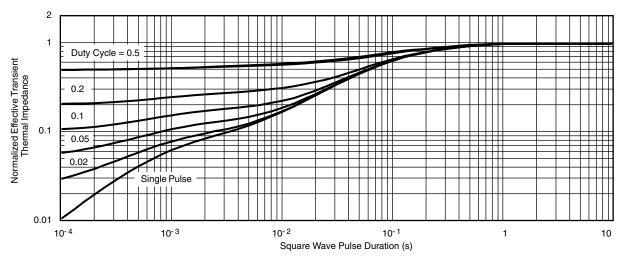
On-Resistance vs. Gate-to-Source Voltage (6.6 A)



Normalized Thermal Transient Impedance, Junction-to-Ambient



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Foot

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Foot (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

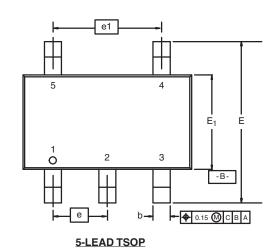
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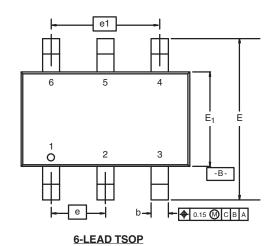


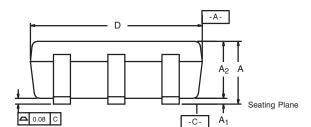


TSOP: 5/6-LEAD

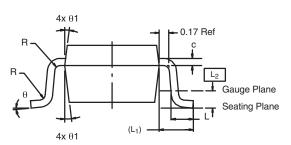
JEDEC Part Number: MO-193C







-C- A₁

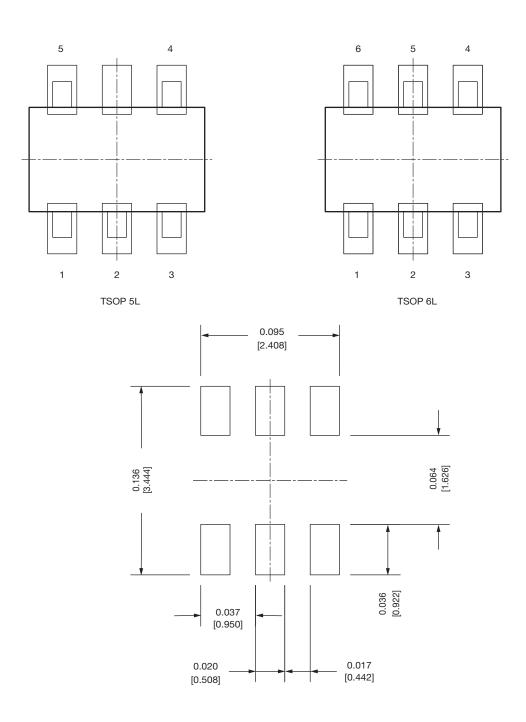


	MILLIMETERS			S INCHES			
Dim	Min	Nom	Max	Min	Nom	Max	
Α	0.91	-	1.10	0.036	-	0.043	
A ₁	0.01	-	0.10	0.0004	-	0.004	
A ₂	0.90	-	1.00	0.035	0.038	0.039	
b	0.30	0.32	0.45	0.012	0.013	0.018	
С	0.10	0.15	0.20	0.004	0.006	0.008	
D	2.95	3.05	3.10	0.116	0.120	0.122	
E	2.70	2.85	2.98	0.106	0.112	0.117	
E ₁	1.55	1.65	1.70	0.061	0.065	0.067	
е	0.95 BSC			0.0374 BSC			
e ₁	1.80	1.90	2.00	0.071	0.075	0.079	
L	0.32	-	0.50	0.012	-	0.020	
L ₁	0.60 Ref				0.024 Ref		
L ₂	0.25 BSC			0.010 BSC			
R	0.10	-	-	0.004	-	-	
θ	0°	4°	8°	0°	4°	8°	
θ_1	7° Nom			7° Nom			
ECN: C-06593-Rev. I, 18-Dec-06 DWG: 5540							

Document Number: 71200 www.vishay.com 18-Dec-06



Recommended Land Pattern For TSOP-5L / TSOP-6L



Note

• All dimensions are in inches (millimeter)

ECN: C22-0860-Rev. B, 24-Oct-2022 DWG: 3010



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